AN5730

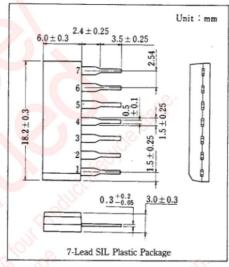
B/W TV Sound IF Amplifier, Detector Circuit

Outline

The AN5730 is one of IC's for the AN5700 series low voltage operation (6V) and small Black/White TV. It is an integrated circuit for B/W TV video sound IF amplifier and detector circuit.

Features

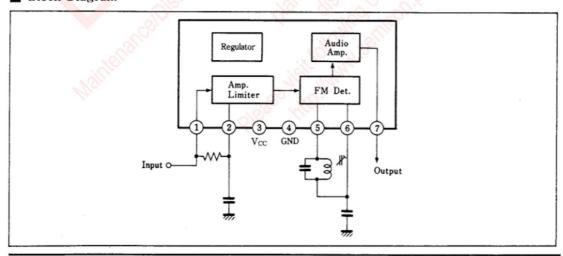
- · Highly stable operation over a wide range of supply voltage
- Good ripple rejection: RR = -30dB max.



Pin

Pin No.	Pin Name
1	SIF Input
2	Decoupling
3	Vcc
4	GND
5	SIF Output
6	Detector
7	Detector Output

■ Block Diagram



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■ Absolute Maximum Ratings (Ta=25°C)

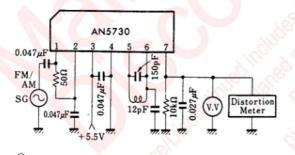
Supply voltage Power Dissipation		Symbol	Rating	Unit V mW	
		Vcc	7.2		
		Pp	98		
Temperature	Operating Ambient Temperature	Торг	-20~+70	°C	
	Storage Temperature	Tstg	-40~+150	°C	

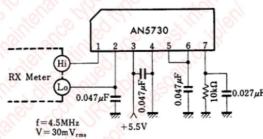
■ Electrical Characteristics (Ta=25°C)

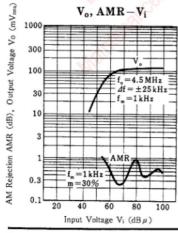
Item	Symbol	Test Circuit	Condition Vcc=5.5V		typ.	max.	Unit
Total Circuit Current	Itot				9.0	12.0	mA
Input Limiting Voltage	V _{i(lim)}	1	$f_0=4.5MHz, f_m=1kHz, \\ \Delta f = \pm 25kHz$		300	500	μV
Output Voltage (Det.)	V _o	1	$f_0=4.5 \text{MHz}, f_m=1 \text{kHz}, \Delta f=\pm 25 \text{kHz}$ $V_i=100 \text{mV}_{\text{rms}}$		100	130	mV rms
Total Harmonic Distortion(Det.)	THD	1			1	2	%
AM Rejection	AMR	1	$f_0=4.5 MHz$, $f_m=1kHz$ $AM=30\%$, $V_i=100 mV_{rms}$	34	40		dB
Ripple Rejection Ratio	RR		V ₇₋₄ change when V _{cc} is 4.5V and 5.5V			-30	dB
Input Resistance	Ri	2	f=4.5MHz, V _i =30mV _{rms}		15		kΩ
Input Capacitance	Ci	2			6		pF

Test Circuit 1 (Victim), Vo, THD, AMR)

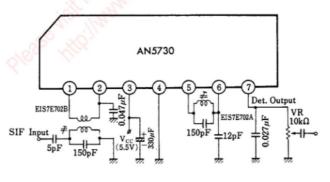
Test Circuit 2 (Ri, Ci)







Application Circuit



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